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[Torex Semiconductor Ltd](#)

[XC8102AA01MR-G](#)

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XC8102 Series

ETR2502-009

Load Switch with Low On-Resistance (Current Limit 400mA)

■ GENERAL DESCRIPTION

The XC8102 series is a low ON resistance load switch IC with ON/OFF control and output current protection which integrates a P-channel MOSFET.

By connecting the XC8102 to the output pin of a step-down DC/DC converter, the CE pin controls ON/OFF for each distribution switch to deliver power per requirements and maximize total power efficiency. As a result, the XC8102 helps to extend battery life and product operation time.

The series contains a current limit and protection circuit so these are not required externally unlike discrete circuit solutions where MOSFETs and resistors are used.

When a low signal is input to the CE pin, the series enters stand-by mode. Even where a load capacitor is connected to the output pin during stand-by, the electric charge stored at the load capacitor is discharged through the internal switch. As a result, the V_{OUT} pin voltage falls quickly to the V_{SS} level.

The series contains over current protection with fold-back current circuitry which operates as over current protection and short circuit protection for the output pin.

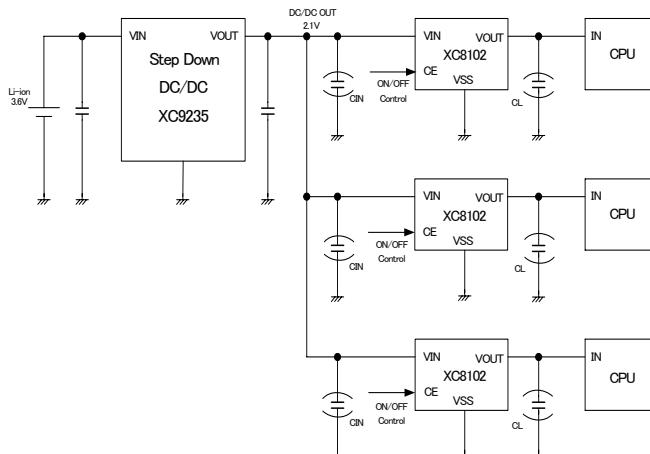
■ APPLICATIONS

- Smart phones / Mobile phones
- Digital still cameras / Camcorders
- Portable game consoles

■ FEATURES

On Resistance	: 0.28Ω@ V _{IN} =6.0V (TYP.) 0.31Ω@ V _{IN} =4.0V (TYP.) 0.35Ω@ V _{IN} =2.9V (TYP.) 0.52Ω@ V _{IN} =1.8V (TYP.) 0.60Ω@ V _{IN} =1.5V (TYP.) 0.80Ω@ V _{IN} =1.2V (TYP.)
Input Voltage Range	: 1.2V~6.0V
Power Consumption	: 3.0 μA@ V _{IN} =1.2V 3.6 μA@ V _{IN} =2.9V 4.0 μA@ V _{IN} =6.0V
Stand-by Current	: 0.1 μA
Protection Circuit	: Current limit(Output Current) 400mA (1.8≤V _{IN} ≤6.0V) Short-circuit Protection, Short current= 30mA (TYP.)
ON/OFF Function	: Active High Enable High-Speed Discharge Function
Operating Ambient Temperature	: -40°C~+85°C
Packages	: USP-4,SSOT-24, SOT-25 USPN-4
Environmentally Friendly	: EU RoHS Compliant, Pb Free

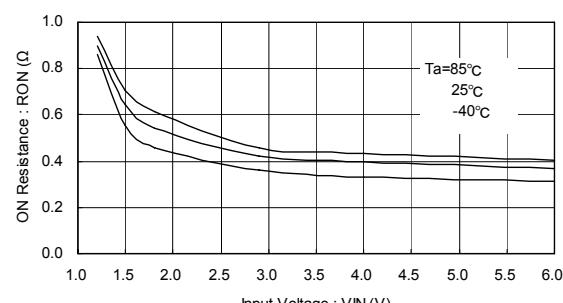
■ TYPICAL APPLICATION CIRCUIT



■ TYPICAL PERFORMANCE CHARACTERISTICS

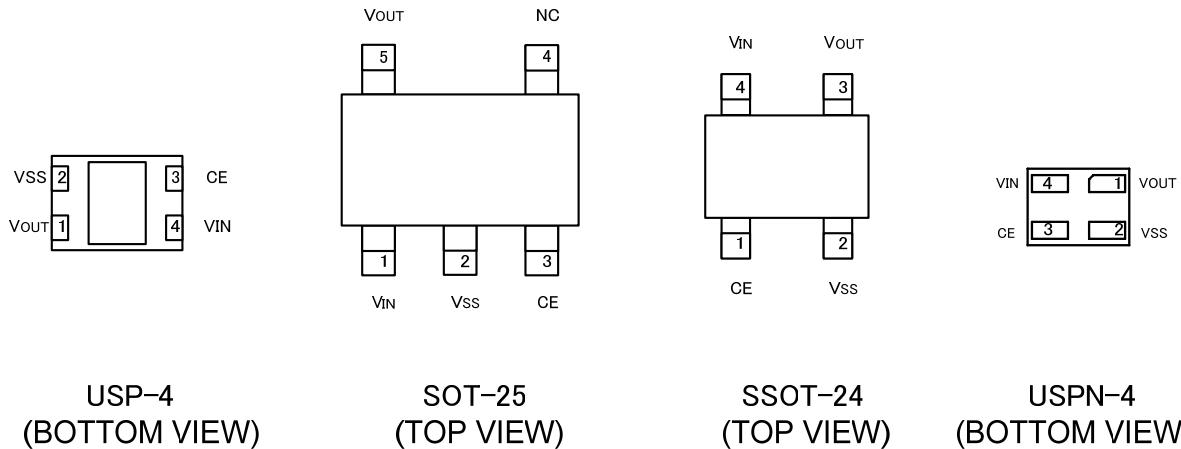
● On Resistance vs. Input Voltage

XC8102AA01M/XC8102AA01G
 VIN=CE
 IOUT=50mA
 CIN=None, CL=None



XC8102 Series

■ PIN CONFIGURATION



*The heat dissipation pad of the USP-4 package is recommended to solder as shown in the recommended mount pattern and metal mask pattern for mounting strength. The heat dissipation pad should be electrically opened or connected to the V_{SS} (No. 2) pin.

■ PIN ASSIGNMENT

PIN NUMBER				PIN NAME	FUNCTIONS
USP-4	SOT-25	SSOT-24	USPN-4		
4	1	4	4	V _{IN}	Power Input
1	5	3	1	V _{OUT}	Output
2	2	2	2	V _{SS}	Ground
3	3	1	3	CE	ON/OFF Control
—	4	—	-	NC	No Connection

■ PRODUCT CLASSIFICATION

● Ordering Information

XC8102①②③④⑤⑥-⑦^{(*)1}

DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
①	CE pin logic	A	CE High active
②	C _L Discharge Function	A	Output capacitor (C _L) auto-discharge function integrated
③④	Internal Standard Number	01	Fixed
⑤⑥-⑦ ^{(*)1}	Packages (Order Unit)	GR-G	USP-4 (3,000/Reel)
		MR-G	SOT-25 (3,000/Reel)
		NR-G	SSOT-24 (3,000/Reel)
		7R-G	USPN-4 (5,000/Reel)

^{(*)1} The “-G” suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant.

■FUNCTION CHART

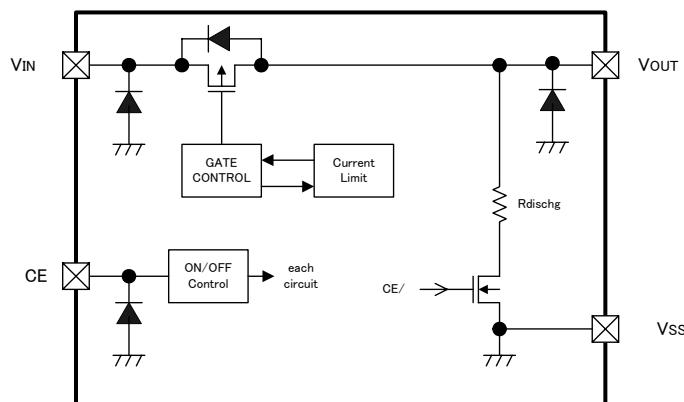
SERIES	CE	IC OPERATIONAL STATUS ON/OFF
XC8102AA01	H	ON
	L	OFF
	OPEN	Undefined state

H = High Level

L = Low Level

* CE pin should not be left open.

■BLOCK DIAGRAM



XC8102AA Series

* Diodes inside the circuit are an ESD protection diode and a parasitic diode.

■ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATINGS	UNITS
Input Voltage	V _{IN}	-0.3~+6.5	V
Output Current	I _{OUT}	850 ^{(*)1}	mA
		750(USPN-4) ^{(*)1}	
Output Voltage	V _{OUT}	-0.3~V _{IN}	V
CE Input Voltage	V _{CE}	-0.3~+6.5	V
Power Dissipation	USP-4	120	mW
	SSOT-24	150	
	SOT-25	250	
	USPN-4	100	
Operating Ambient Temperature	T _{opr}	-40~+85	°C
Storage Temperature	T _{stg}	-55~+125	°C

(*)1 Please make sure that I_{OUT} is less than Pd/ (V_{IN}-V_{OUT})

XC8102 Series

■ ELECTRICAL CHARACTERISTICS

● XC8102 Series

T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUITS
Input Voltage	V _{IN}		1.2	-	6.0	V	-
On Resistance (SSOT-24/USPN-4)	R _{ON}	V _{IN} =6.0V, V _{CE} =V _{IN}	-	0.28	0.425	Ω	①
		V _{IN} =4.0V, V _{CE} =V _{IN}	-	0.31	0.475		
		V _{IN} =2.9V, V _{CE} =V _{IN}	-	0.35	0.475		
		V _{IN} =1.8V, V _{CE} =V _{IN}	-	0.52	0.625		
		V _{IN} =1.5V, V _{CE} =V _{IN}	-	0.60	0.80		
		V _{IN} =1.2V, V _{CE} =V _{IN}	-	0.80	1.60		
On Resistance (SOT-25/USP-4)	R _{ON}	V _{IN} =6.0V, V _{CE} =V _{IN}	-	0.35	0.475	Ω	①
		V _{IN} =4.0V, V _{CE} =V _{IN}	-	0.38	0.525		
		V _{IN} =2.9V, V _{CE} =V _{IN}	-	0.43	0.525		
		V _{IN} =1.8V, V _{CE} =V _{IN}	-	0.59	0.675		
		V _{IN} =1.5V, V _{CE} =V _{IN}	-	0.67	0.85		
		V _{IN} =1.2V, V _{CE} =V _{IN}	-	0.87	1.65		
Supply Current	I _{DD}	V _{IN} =6.0V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	4.0	7.0	μA	②
		V _{IN} =4.0V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	3.8	6.5		
		V _{IN} =2.9V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	3.6	6.3		
		V _{IN} =1.8V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	3.4	5.7		
		V _{IN} =1.5V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	3.2	5.5		
		V _{IN} =1.2V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	3.0	4.9		
Stand-by Current	I _{STBY}	V _{IN} =6.0V, V _{CE} =V _{SS} , V _{OUT} =OPEN	-	0.01	0.10	μA	②
Switch Leakage Current	I _{LEAK}	V _{IN} =6.0V, V _{CE} =V _{SS} , V _{OUT} =0V	-	0.01	0.10	μA	②
Current Limit	I _{LIM}	V _{IN} ≥2.9V, V _{OUT} =V _{IN} -0.8V	400	480	-	mA	①
		1.8V≤V _{IN} <2.9V, V _{OUT} =V _{IN} -0.6V	400	480	-		
		1.5V≤V _{IN} <1.8V, V _{OUT} =1.2V	200	-	-		
		1.2V≤V _{IN} <1.5V, V _{OUT} =1.0V	90	-	-		
Short Circuit Current	I _{SHORT}	V _{CE} =V _{IN} , V _{OUT} =0V	-	30	75	mA	①
CE High Level Voltage	V _{CEH}		1.1	-	6.0	V	③
CE Low Level Voltage	V _{CEL}		-	-	0.3	V	③
CE High Level Current	I _{CEH}	V _{CE} =V _{IN}	-0.1	-	0.1	μA	③
CE Low Level Current	I _{CEL}	V _{CE} =V _{SS}	-0.1	-	0.1	μA	③
C _L Auto-Discharge Resistance	R _{DCHG}	V _{IN} =4.0V, V _{OUT} =4.0V, V _{CE} =V _{SS}	380	480	570	Ω	④
Turn On Time ^{(*)1}	t _{DLY(ON)}	V _{IN} =4.0V, V _{CE} =0.3V→1.2V, R _L =80Ω, without C _{IN} , C _L	-	8.5	18	μs	⑤
Turn Off Time ^{(*)2}	t _{DLY(OFF)}	V _{IN} =4.0V, V _{CE} =1.2V→0.3V, R _L =80Ω, without C _{IN} , C _L	-	3.0	7.5	μs	⑤

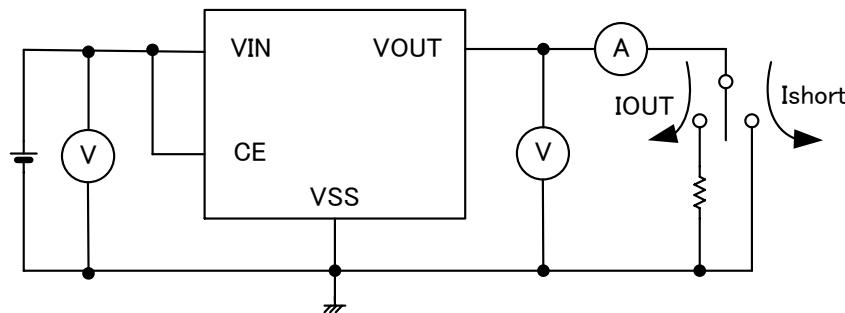
NOTE:

*1: Time to reach 90% of V_{OUT} after V_{CE} entering the V_{CEH} threshold.

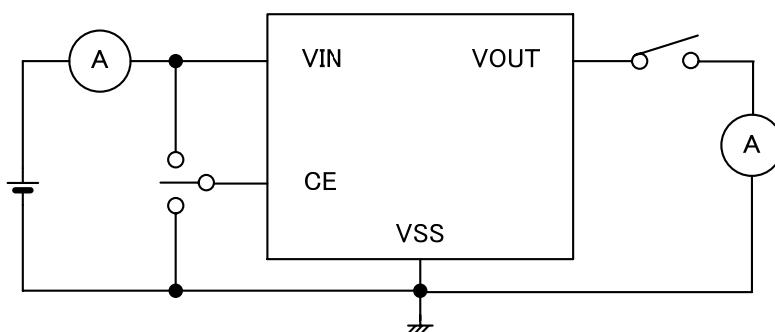
*2: Time to fall to 10% of V_{OUT} after V_{CE} entering the V_{CEL} threshold.

■ TEST CIRCUITS

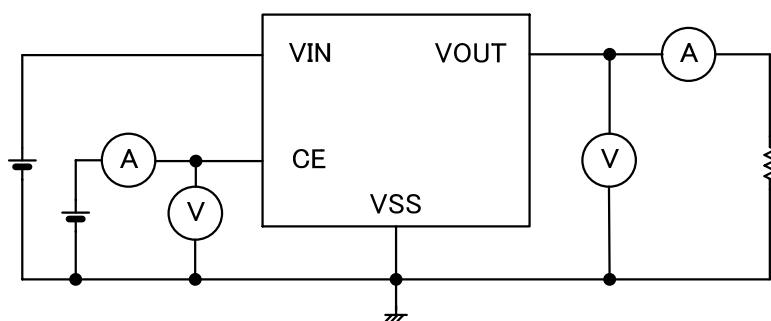
Circuit ①



Circuit ②



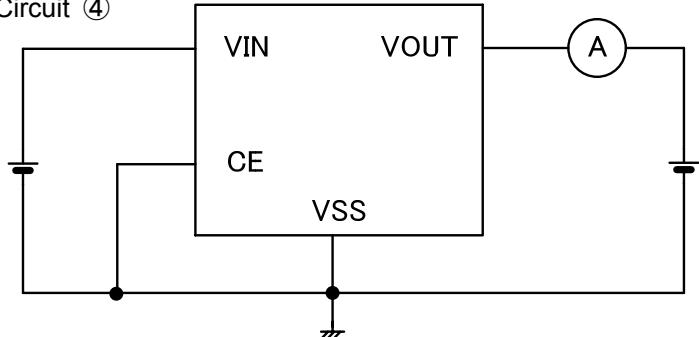
Circuit ③



XC8102 Series

■ TEST CIRCUITS (Continued)

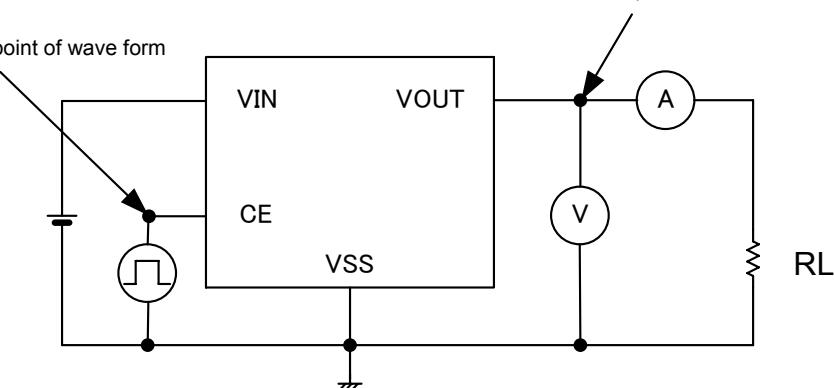
Circuit ④



Circuit ⑤

The measurement point of wave form

The measurement point of wave form



■OPERATIONAL EXPLANATION

<CE Pin>

The XC8102 enables an output P-channel MOSFET switch and the IC internal circuitry to turn off by the signal to the CE pin. In the shutdown mode, the V_{OUT} pin will be pulled down to the V_{SS} by the C_L auto-discharge function.

The output voltage becomes unstable when the CE pin is opened. If the input voltage to the CE pin is within the specified threshold voltages, the logic is fixed and the XC8102 will operate normally. However, supply current may increase as a result of the shoot-through current of internal circuitry when the medium level voltage is input to the CE pin.

<Input/Output Capacitor>

The XC8102 works well without an input and output capacitors. Also, an output capacitor of the power source can be used as an input capacitor of the XC8102 and a bypass capacitor of the driving IC can be used as an output capacitor of the XC8102.

<C_L Auto-Discharge Function>

The XC8102AA contains a C_L auto-discharge resistor and an N-channel transistor between the V_{OUT} pin and the V_{SS} pin. The device quickly discharge the electric charge in the output capacitor (C_L) when a low signal to the CE pin is input to turn off a whole IC circuit. The C_L auto-discharge resistance is set at 480Ω (V_{OUT}=4.0V TYP. @ V_{IN}=4.0). Discharge time of the output capacitor (C_L) is determined by a C_L auto-discharge resistor value (Rdischg) and an output capacitor value. Time constant τ is defined as ($\tau = C \times R_{\text{dischg}}$). Output voltage after starting discharge can be calculated by the following formula.

$$V = V_{\text{OUT}} \times e^{-t/\tau}, \quad \text{or} \quad t = \tau \ln(V_{\text{OUT}} / V)$$

V: Output voltage after starting discharge,

V_{OUT}: Output voltage,

t : Discharge time,

τ : Output discharge resistor value Rdischg × Output capacitor (C_L) value C

<Current Limiter, Short-Circuit Protection>

The XC8102 series contains a constant current limiter and fold-back current circuitry. The constant current limiter operates to limit output current and the fold-back current circuitry operates as short circuit protection for the output pin.

When the load current reaches the limit current, the constant current limiter operates and the output voltage drops. The output voltage further, then the fold-back current circuitry operates to decrease the output current. When the output pin is short-circuited to the ground, the output current drops and maintains a flow about 30mA.

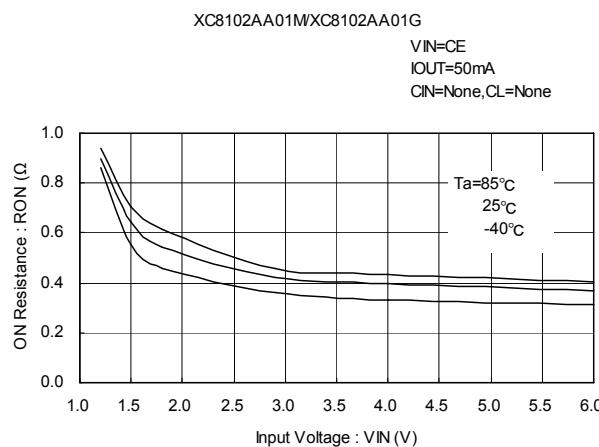
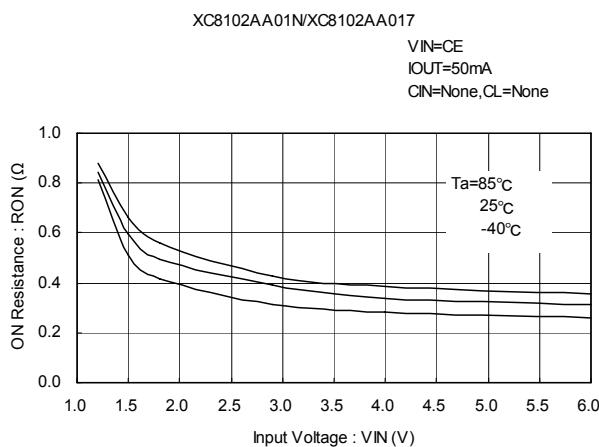
■NOTES ON USE

1. For temporary, transitional voltage drop or voltage rising phenomenon, the IC is liable to malfunction should the ratings be exceeded.
2. The XC8102 goes into an undefined operation when the CE pin is left open. The CE pin shall be tied to low or high level.
3. V_{OUT} pin voltage should not be applied beyond the V_{IN} pin voltage.
The IC may get damage due to the reverse current toward the V_{IN} pin.
4. The XC8102 has constant current start-up.
Please keep the start-up sequence to draw load current after raising the output voltage.
5. Current limit function is integrated. However, power dissipation may be beyond the limit before starting a fold-back current protection when used in high temperature. For the power dissipation of each package, please refer to the graphs of Package Power vs. Operating Temperature in page 15 to 18.
6. Torex places an importance on improving our products and their reliability.
We request that users incorporate fail-safe designs and post-aging protection treatment when using Torex products in their systems.

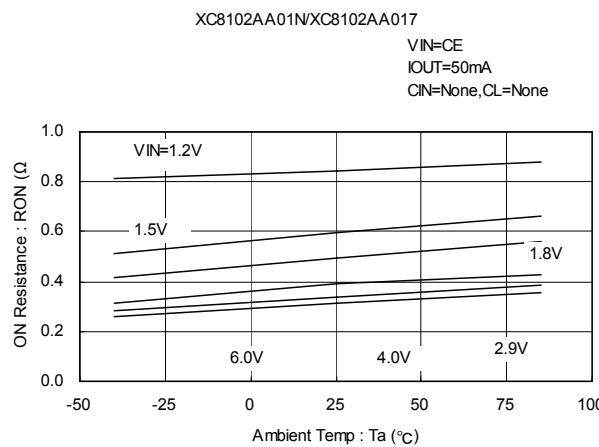
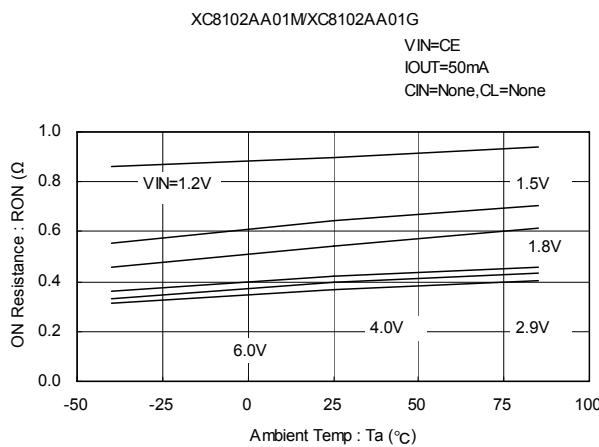
XC8102 Series

■ TYPICAL PERFORMANCE CHARACTERISTICS

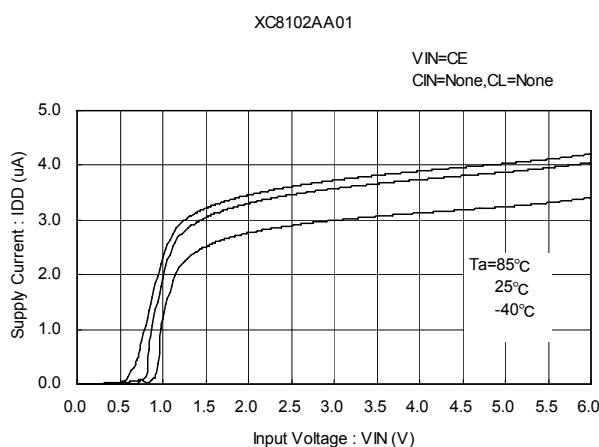
(1) ON Resistance vs. Input Voltage



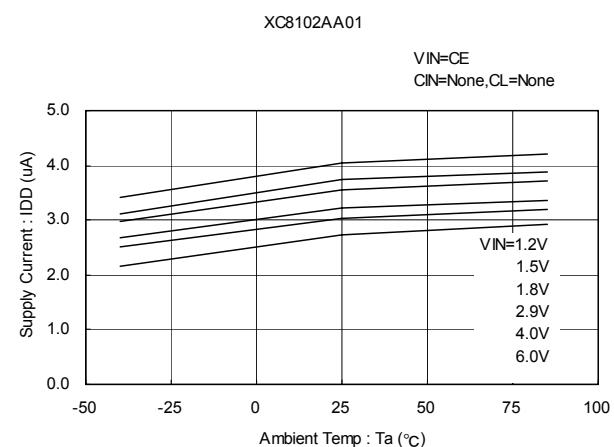
(2) ON Resistance vs. Ambient Temperature



(3) Supply Current vs. Input Voltage

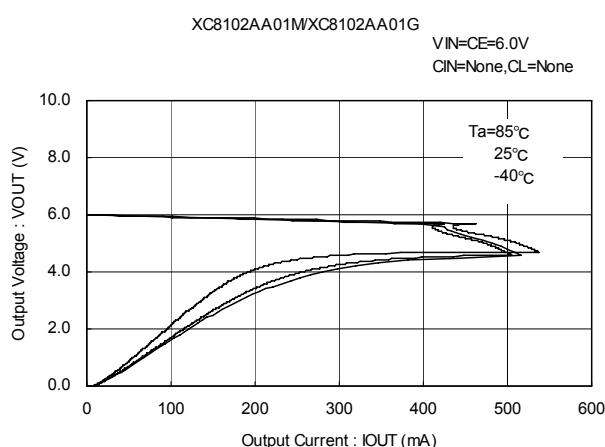
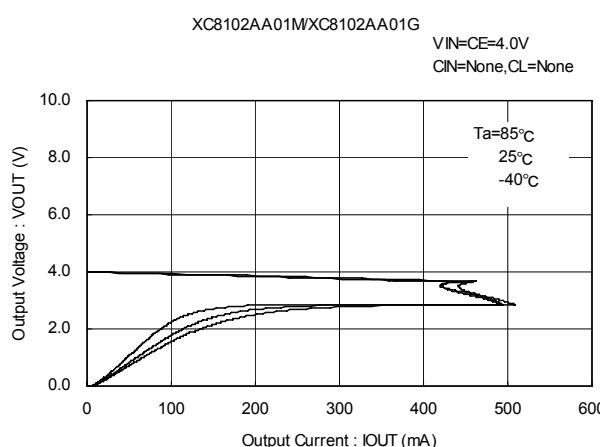
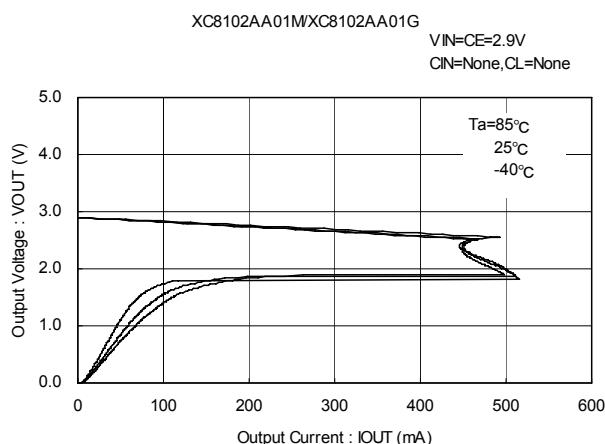
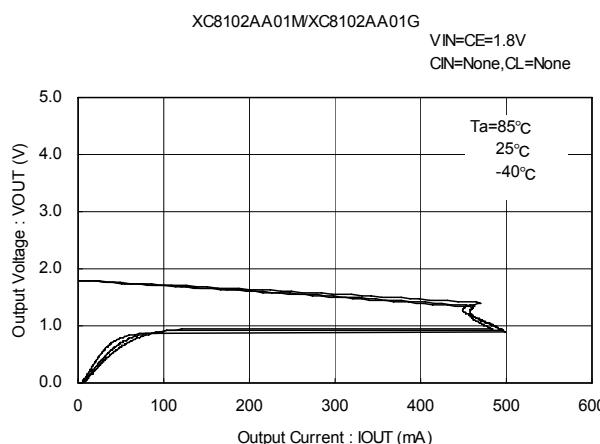
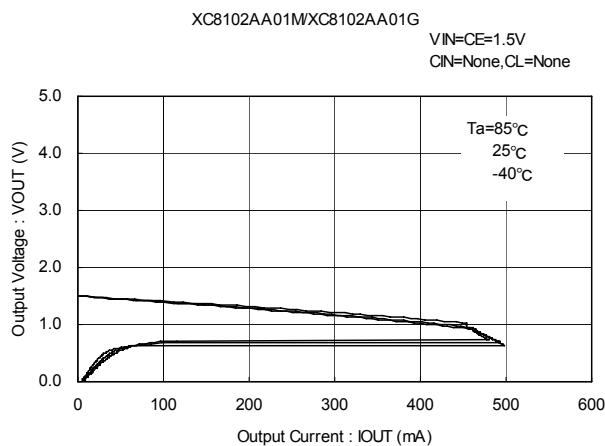
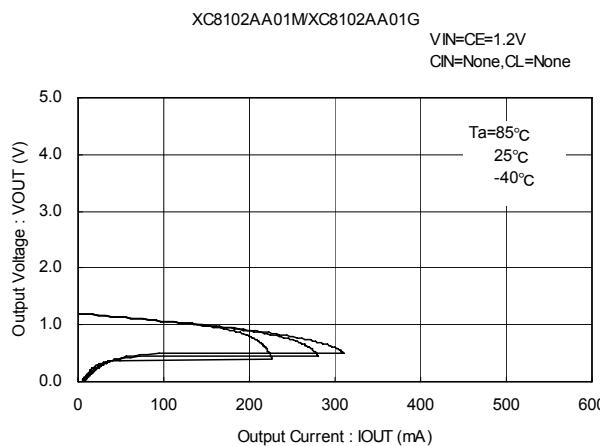


(4) Supply Current vs. Ambient Temperature



■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

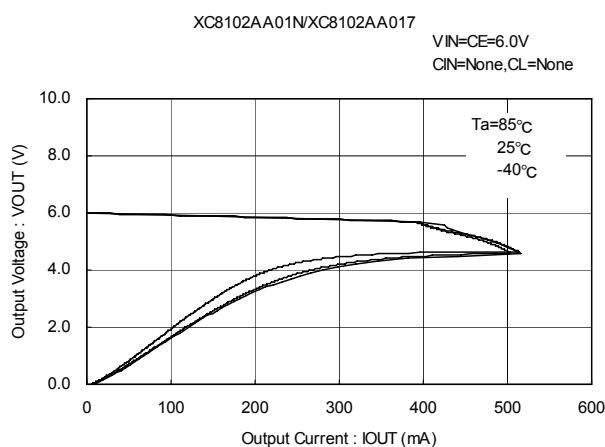
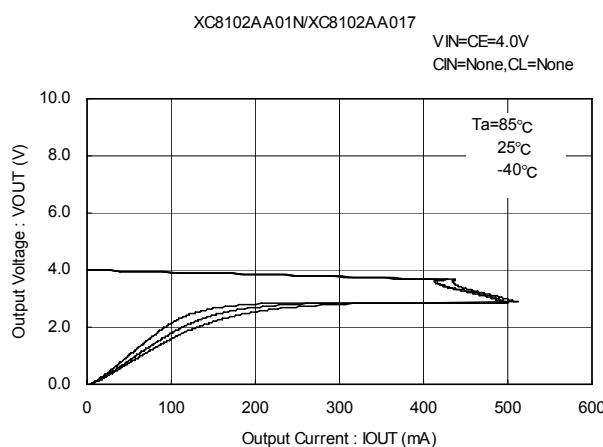
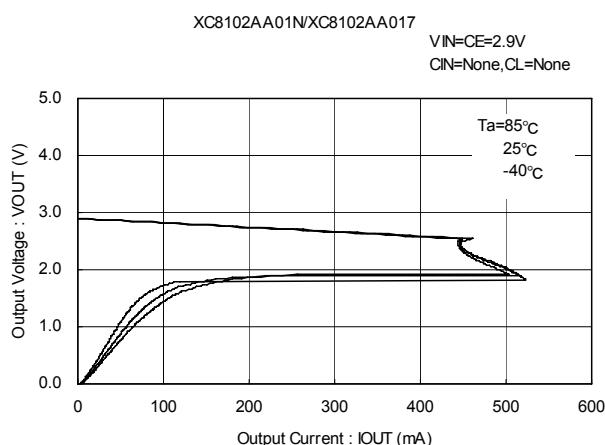
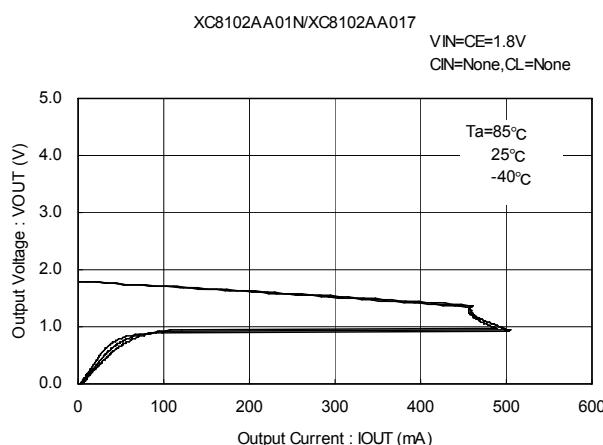
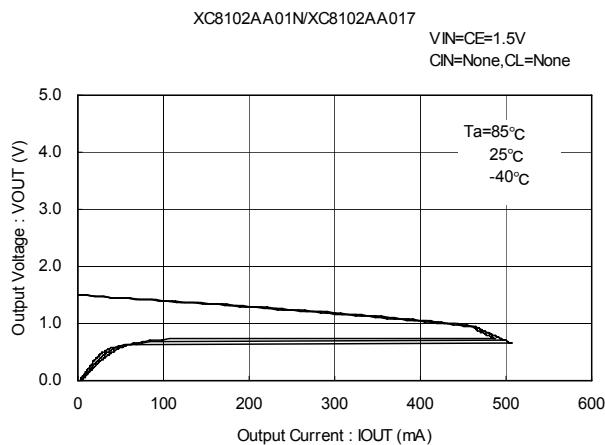
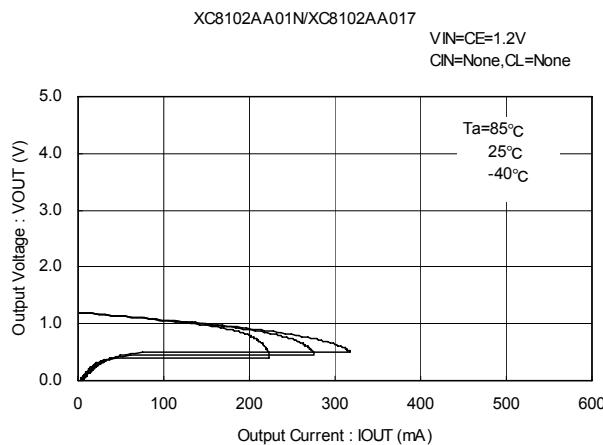
(5) Output Voltage vs. Output Current



XC8102 Series

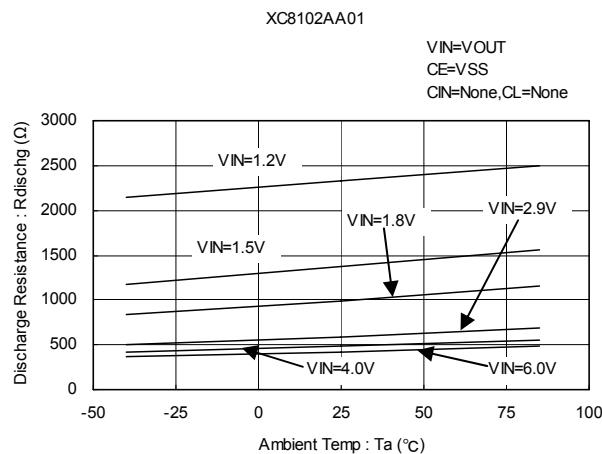
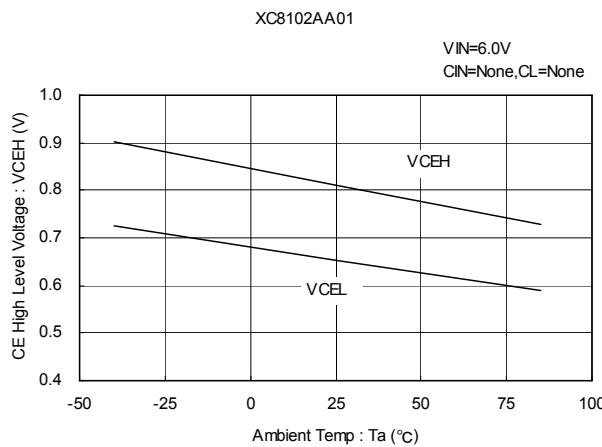
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(5) Output Voltage vs. Output Current

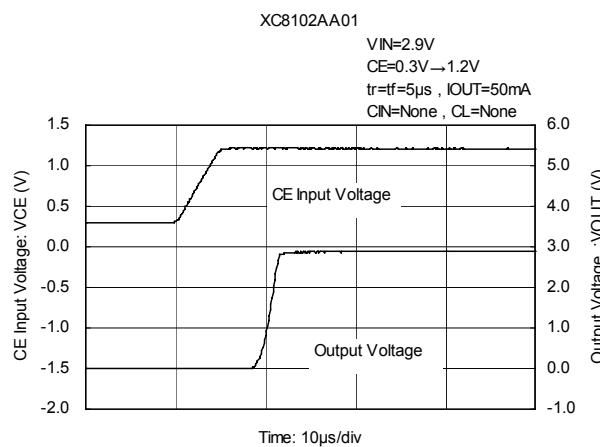
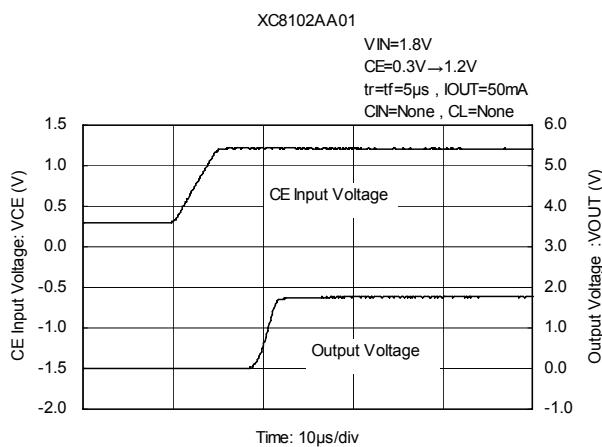
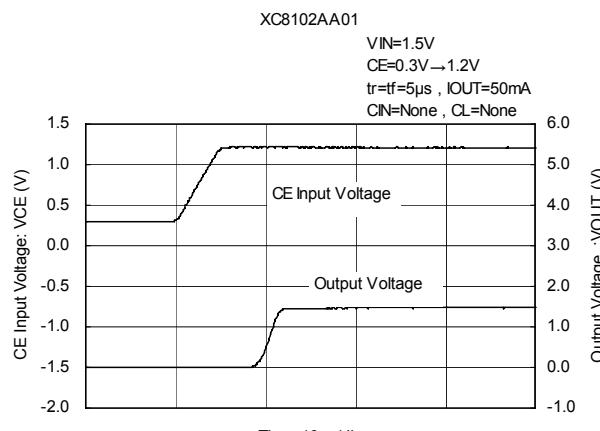
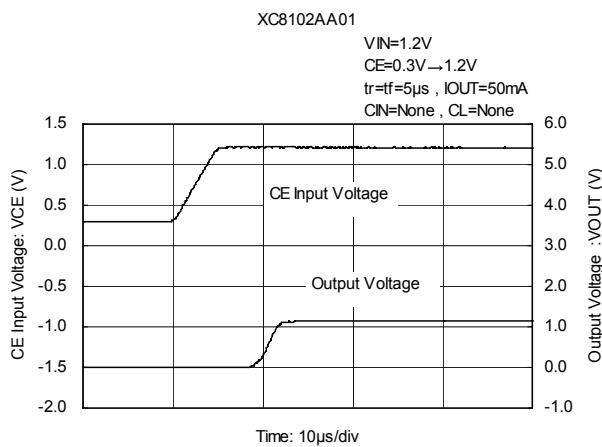


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(6) CE Threshold Voltage vs. Ambient Temperature (7) CL Discharge Resistance vs. Ambient Temperature



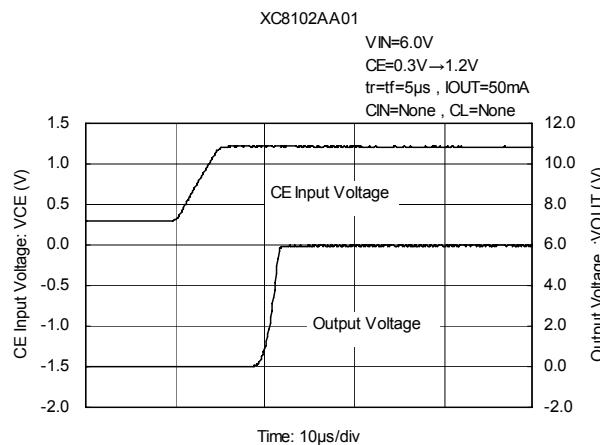
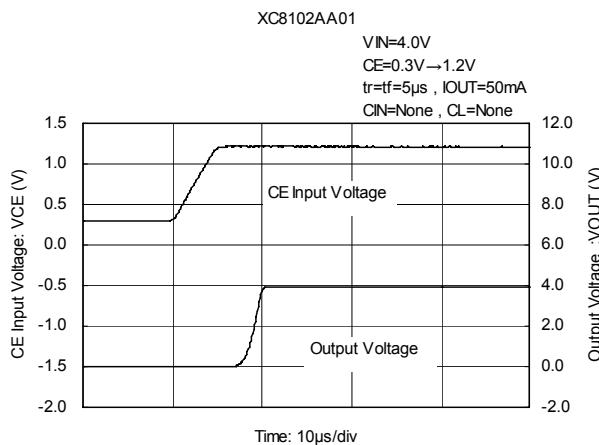
(8) Output Turn-on Time with CE



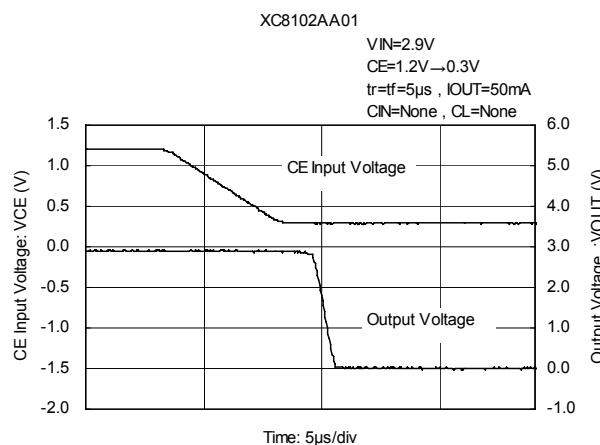
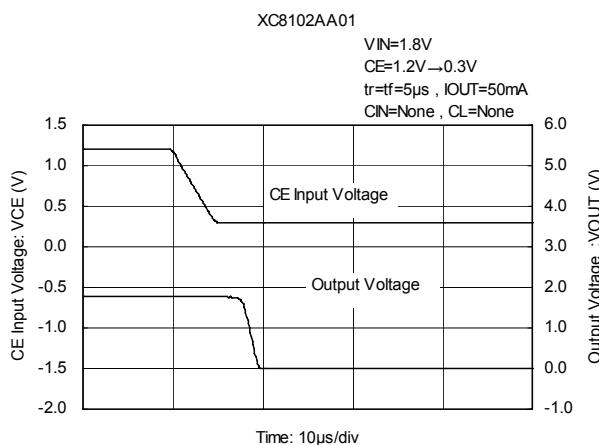
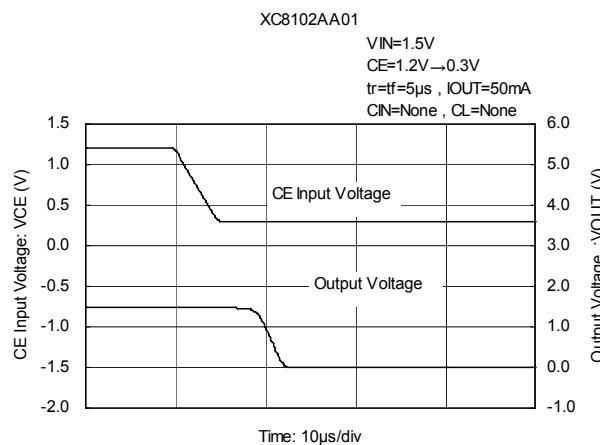
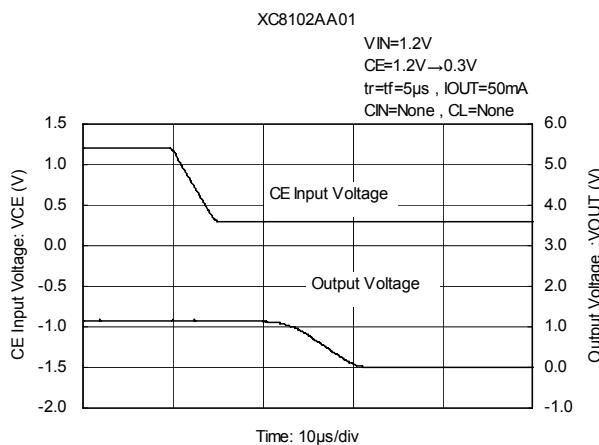
XC8102 Series

■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Output Turn-on Time with CE (Continued)

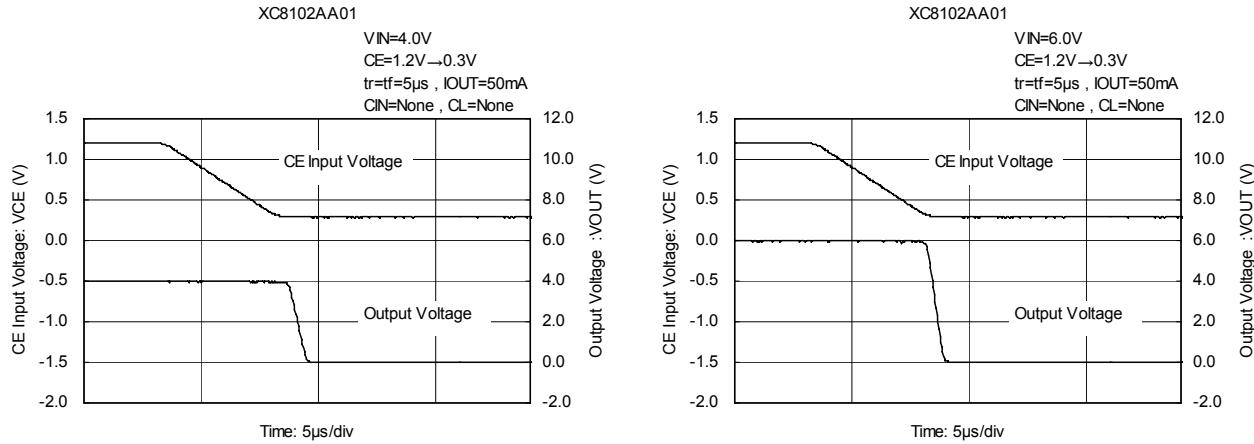


(9) Output Turn-off Time with CE



■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

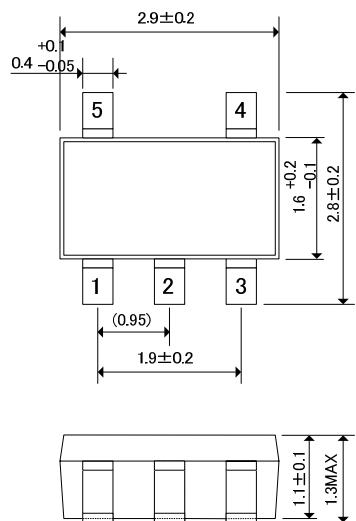
(9) Output Turn-off Time with CE (Continued)



XC8102 Series

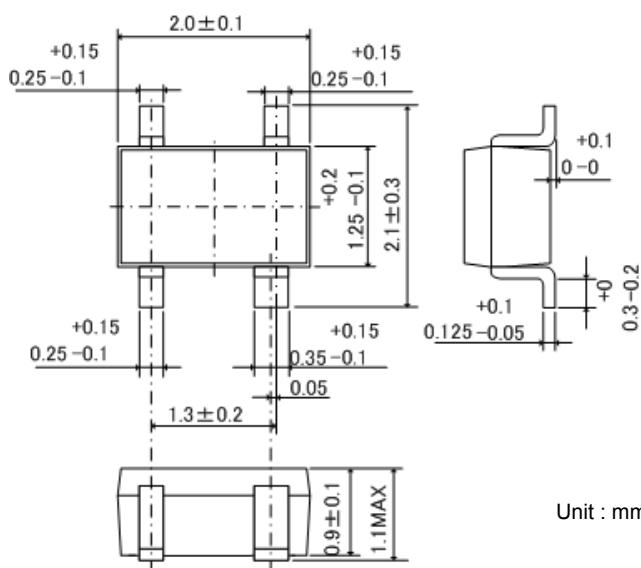
■PACKAGING INFORMATION

●SOT-25



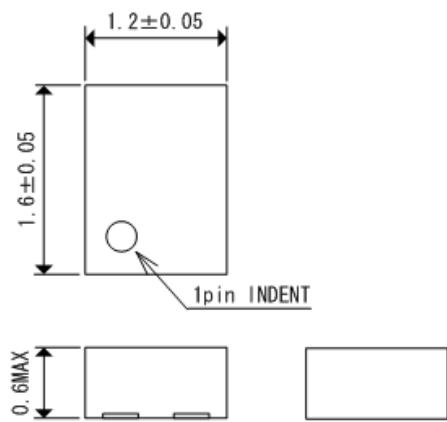
Unit : mm

●SSOT-24



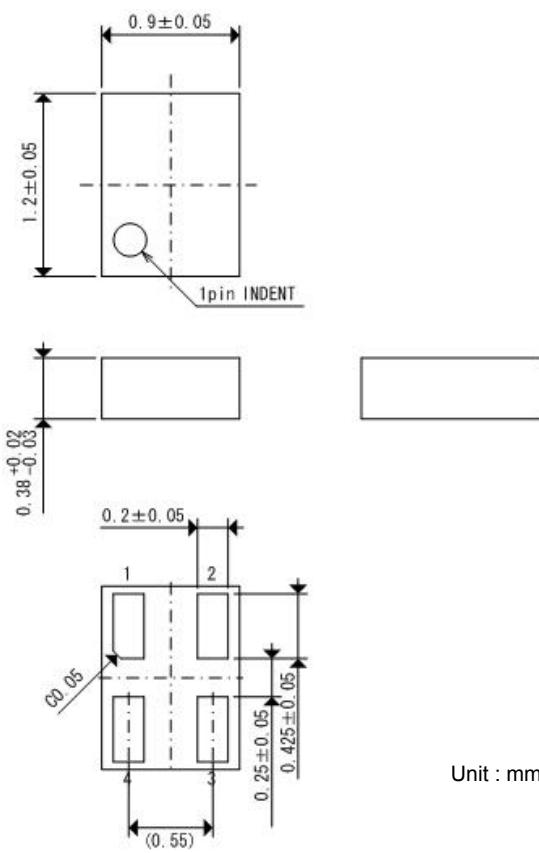
Unit : mm

●USP-4



Unit : mm

●USPN-4



Unit : mm

■PACKAGING INFORMATION (Continued)

- SOT-25 Power Dissipation

Power dissipation data for the SOT-25 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition: Mount on a board

Ambient: Natural convection

Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

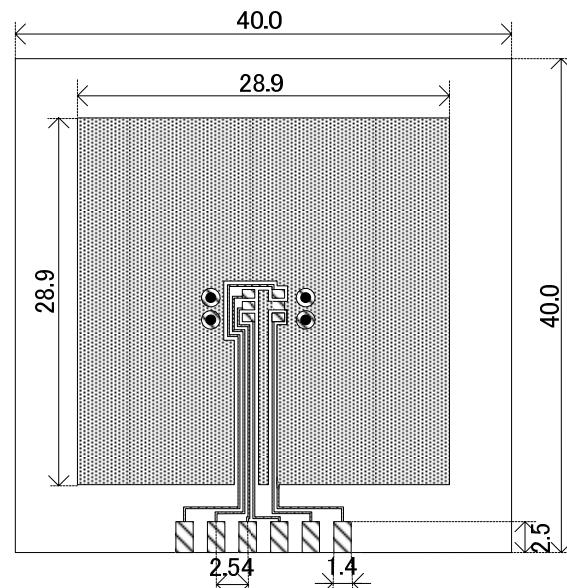
Copper (Cu) traces occupy 50% of the board area
 In top and back faces

Package heat-sink is tied to the copper traces
 (Board of SOT-26 is used)

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

Through-hole: 4 x 0.8 Diameter

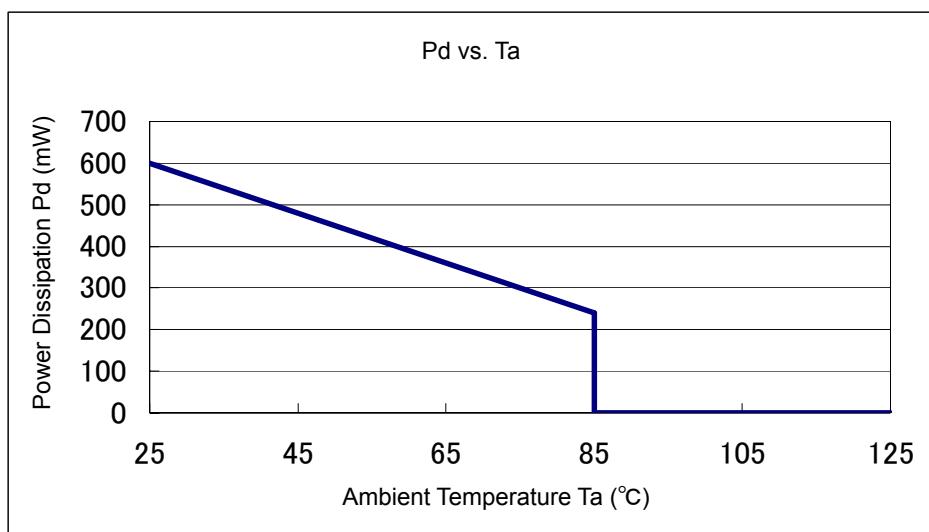


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

Board Mount (T_j max = 125°C)

Ambient Temperature (°C)	Power Dissipation P_d (mW)	Thermal Resistance (°C/W)
25	600	166.67
85	240	



XC8102 Series

■ PACKAGING INFORMATION (Continued)

- SSOT-24 Power Dissipation

Power dissipation data for the SSOT-24 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition: Mount on a board

Ambient: Natural convection

Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

Copper (Cu) traces occupy 50% of the board area

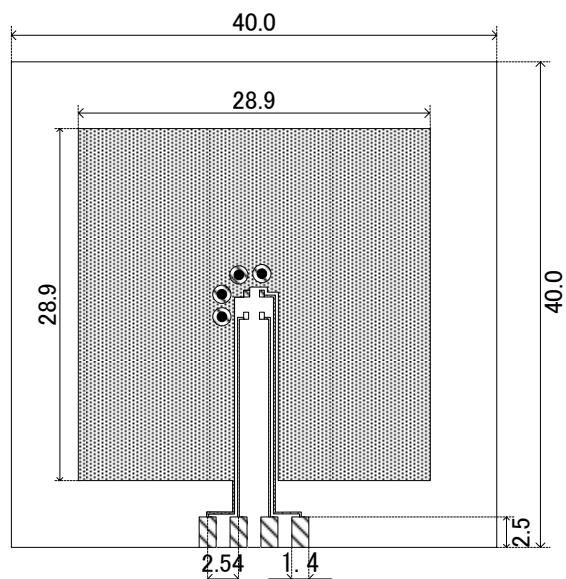
In top and back faces

Package heat-sink is tied to the copper traces

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

Through-hole: 4 x 0.8 Diameter

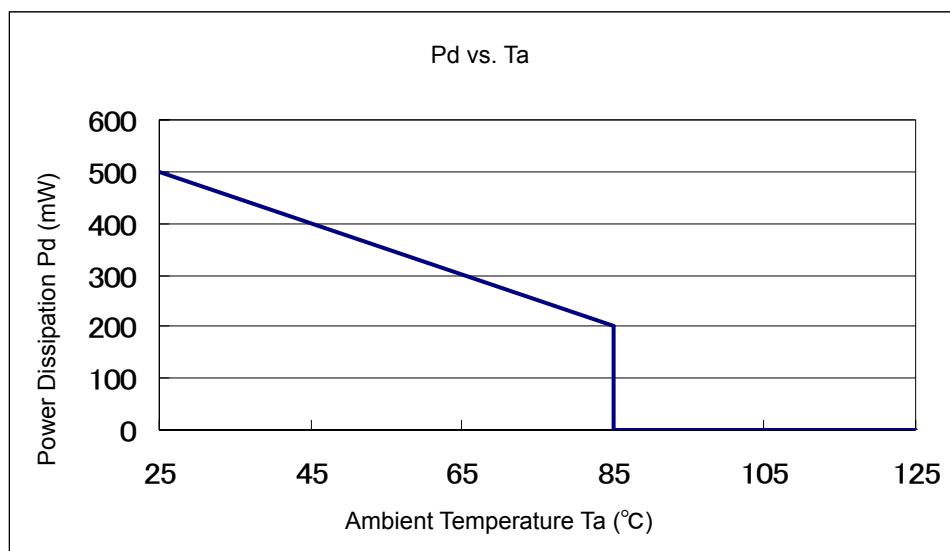


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

Board Mount (T_j max = 125°C)

Ambient Temperature (°C)	Power Dissipation P_d (mW)	Thermal Resistance (°C/W)
25	500	200.00
85	200	



■PACKAGING INFORMATION (Continued)

- USP-4 Power Dissipation

Power dissipation data for the USP-4 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition: Mount on a board

Ambient: Natural convection

Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

Copper (Cu) traces occupy 50% of the board area

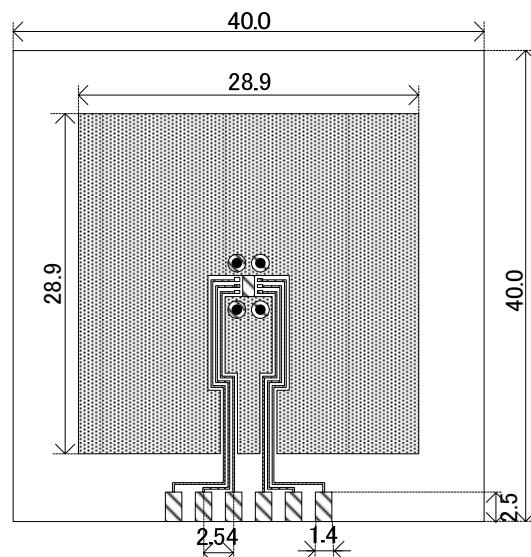
In top and back faces

Package heat-sink is tied to the copper traces

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

Through-hole: 4 x 0.8 Diameter

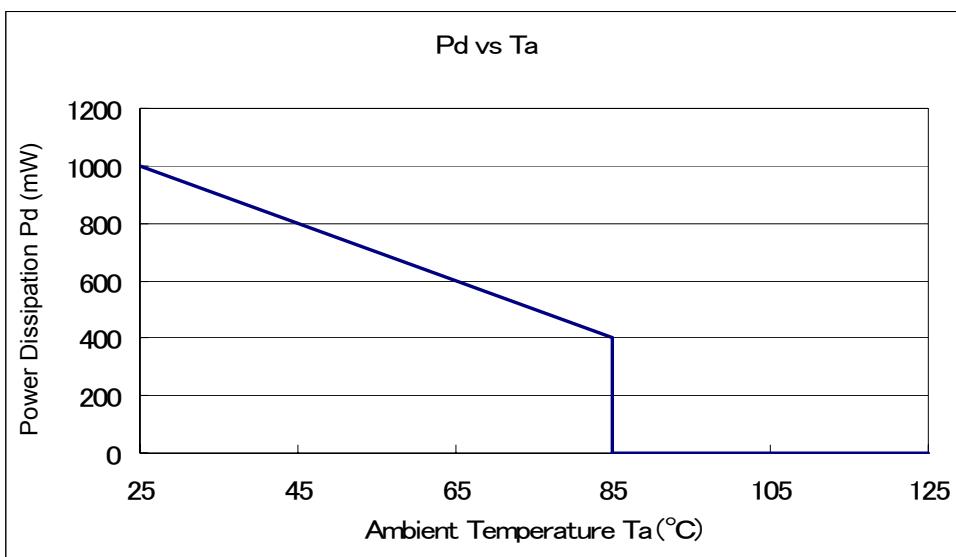


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

Board Mount (T_j max = 125°C)

Ambient Temperature (°C)	Power Dissipation P_d (mW)	Thermal Resistance (°C/W)
25	1000	100.00
85	400	



XC8102 Series

■PACKAGING INFORMATION (Continued)

- USPN-4 Power Dissipation

Power dissipation data for the USPN-4 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition: Mount on a board

Ambient: Natural convection

Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

Copper (Cu) traces occupy 50% of the board area

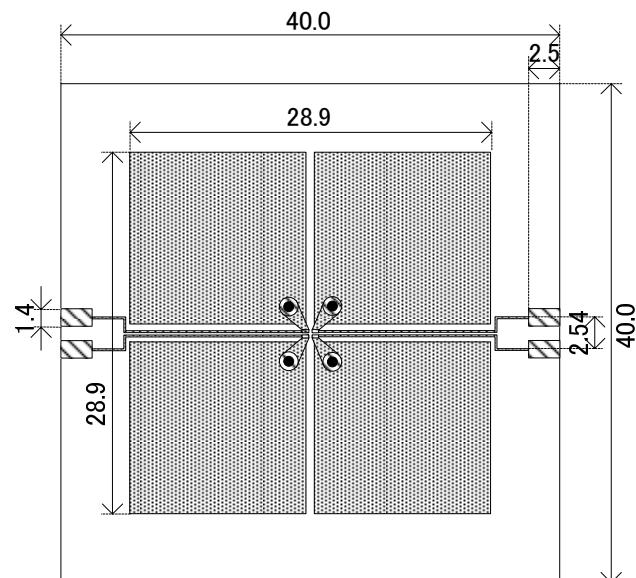
In top and back faces

Package heat-sink is tied to the copper traces

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

Through-hole: 4 x 0.8 Diameter

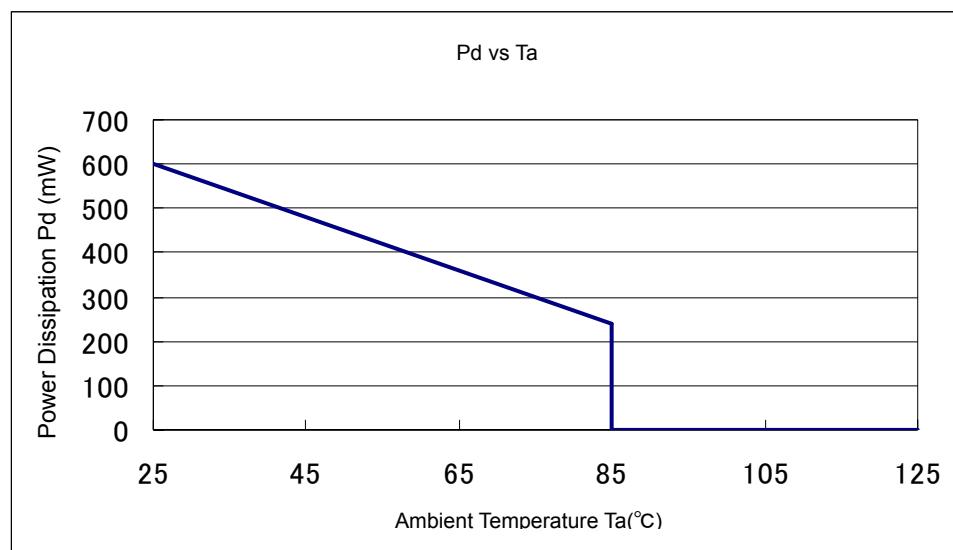


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

Board Mount (T_j max = 125°C)

Ambient Temperature (°C)	Power Dissipation Pd(mW)	Thermal Resistance (°C/W)
25	640	
85	240	166.67

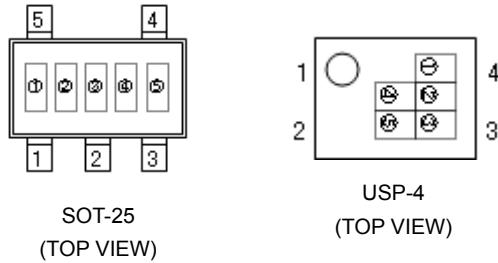


■ MARKING RULE

● SOT-25、USP-4

① represents product series

MARK	PRODUCT SERIES
C	XC8102*****



② represents CE pin logic

MARK	PRODUCT SERIES
F	XC8102A*****

③ represents C_L Discharge Function

MARK	PRODUCT SERIES
C	XC8102*A****

④⑤ represents production lot number

01, ..., 09, 0A, ..., 0Z, 11, ..., 9Z, A1, ..., A9, AA, ..., Z9, ZA, ..., ZZ repeated.

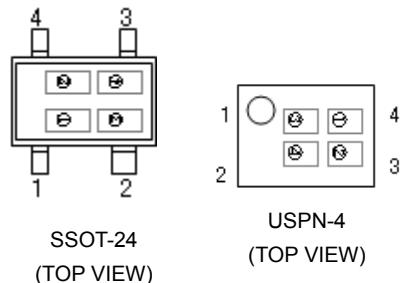
(G, I, J, O, Q, W excluded)

*No character inversion used.

● SSOT-24、USPN-4

① represents product series

MARK	PRODUCT SERIES
C	XC8102*****



② represents CE pin logic and C_L Discharge Function

MARK	PRODUCT SERIES
5	XC8102AA***

③④ represents production lot number

01, ..., 09, 0A, ..., 0Z, 11, ..., 9Z, A1, ..., A9, AA, ..., Z9, ZA, ..., ZZ repeated.

(G, I, J, O, Q, W excluded)

*No character inversion used.

XC8102 Series

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